CMOS 8-Bit Microcontroller

TMPA8700PSN, TMPA8700PSF

The A8700PS is a One-Time PROM microcontroller with low-power 498 Kbits (a 60 Kbytes program memory and a 256 characters OSD font memory) electrically programmable read only memory for the A8700CH / CK / CM / CP / CS and A8701CH / CK / CM system evaluation. The A8700PS is pin compatible with the A8700CH / CK/CM/CP/CS and A8701CH/CK/CM. The operations possible with the A8700CH/CK/CM/CP/CS and A8701CH / CK / CM can be performed by writing programs and OSD font data to PROM. The A8700PS can write and verify in the same way as the TC571000 using an adaptor socket BMA1101 / BMA1102 and an EPROM programmer.

Part No.	OTP	RAM	Package	Adaptor Socket
TMPA8700PSN	60 Kh. daa . 99256 hita	2 Khutaa	SDIP42-P-600-1.78	BMA1101
TMPA8700PSF	60 Kbytes + $8 \times 9 \times 256$ bits	2 Kbytes	QFP44-P-1414-0.80D	BMA1102

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● For a discussion of how the reliability of microcontrollers can be predicted, please refer to Section 1.3 of the chapter entitled

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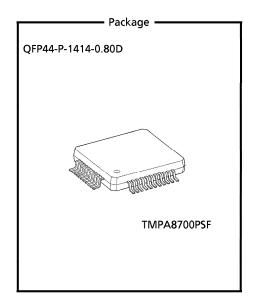
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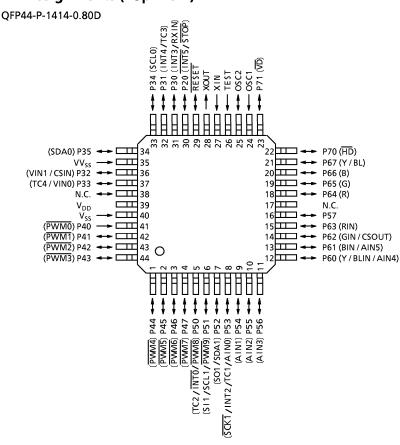
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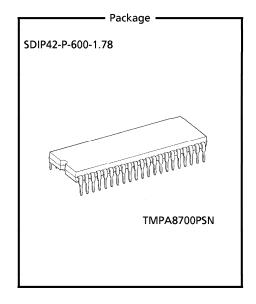


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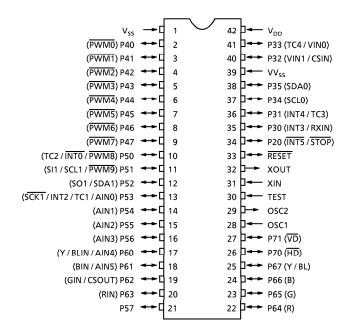
Pin Assignments (Top View)





Pin Assignments (Top View)

SDIP42-P-600-1.78



Pin Function

The A8700PS has two modes: MCU and PROM.

(1) MCU mode

In this mode, the A8700PS is pin compatible with the A8700CH / CK / CM / CP / CS and A8701CH / CK / CM (fix the TEST pin at low level).

(2) PROM mode

Pin Name (PROM Mode)	Input / Output	Functions	Pin Name (MCU Mode)			
A ₁₆			OSC1			
A ₁₅ to A ₁₂	Imm*	DDOM addrage in muite	P35, P34, P31, P30			
A ₁₁ to A ₈	Input	PROM address inputs	P67 to P64			
A ₇ to A ₀			P57 to P50			
D ₇ to D ₀	1/0	PROM data input / outputs	P47 to P40			
CE	la a de	Chip enable signal input (active low)	P33			
ŌĒ	Input	Output enable signal input (active low)	P32			
PGM	Input	Program mode signal input (active low)	OSC2			
V _{PP}		+ 12.75 V / 5 V (Program supply voltage)	TEST			
Vcc	Power supply	+ 6.25 V / 5 V	V _{DD}			
GND		0 V	V _{SS} , VVSS			
P61		DDOM made setting him De fived at high level				
P70		PROM mode setting pin. Be fixed at high level.				
P20						
P63, P62, P60	Input	DDOM was do sotting win Do fined at level and				
P71		PROM mode setting pin. Be fixed at low level.				
RESET						
XIN	Input	Connect on S.M. In assillator to stability the sixty	armal state			
XOUT	Output	Connect an 8 MHz oscillator to stabilize the internal state.				

Operational Description

The following explains the A8700PS hardware configuration and operation. The configuration and functions of the A8700PS are the same as those of the A8700CS, except in that a one-time PROM is used instead of an on-chip mask ROM.

1. Operating Mode

The A8700PS has two modes: MCU and PROM.

1.1 MCU Mode

The MCU mode is activated by fixing the TEST / VPP pin at low level.

In the MCU mode, operation is the same as with the A8700CH / CK / CM / CP / CS (the TEST / V_{PP} pin cannot be used open because it has no built-in pull-down resistance).

Also, without the program corrective function, D / A converted (pulse width modulation) output, remote control signal processor, and RAM addresses $340_{\rm H}$ to $83F_{\rm H}$, the chip operates in the same way as the A8701CH / CK / CM.

Moreover, when using the chip to evaluate the A8701CH / CK / CM, do not set the registers used for these functions.

1.1.1 Program Memory and OSD Character Font Memory

The A8700PS has a 60 Kbytes (addresses 1100_H to FFFF_H in the MCU mode, address 11100_H to 1FFFF_H in the PROM mode) of program memory and a $8 \times 9 \times 256$ bits (addresses 4000_H to 4FFF_H in the PROM mode) of OSD character font memory.

Electrical Characteristics

Absolute Maximum Ratings $(V_{SS} = 0 V)$

Characteristic	Symbol	Pins	Rating	Unit
Supply Voltage	V_{DD}	_	– 0.3 to 6.5	V
Programmable Voltage	V _{PP}	TEST / V _{PP} pin	- 0.3 to 13.0	٧
Input Voltage	V _{IN}	_	-0.3 to V _{DD} + 0.3	٧
Output Voltage	V _{OUT1}	_	-0.3 to V _{DD} + 0.3	٧
Output Current (Per 1pin)	I _{OUT1}	Ports P2, P3, P4, P5, P64 to P67, P7	3.2	
	I _{OUT2}	Ports P60 to P63	30	mA
Output Current (Total)	Σl _{OUT1}	Σl _{OUT1} Ports P2, P3, P4, P5, P64 to P67, P7		
Output Current (Total)	Σl _{OUT2}	Ports P60 to P63	120	mA
Power Dissipation	P _D	_	600	mW
Soldering Temperature (time)	T _{sld}	_	260 (10 s)	°C
Storage Temperature	T _{stg}	_	– 55 to 125	°C
Operating Temperature	T _{opr}	_	– 30 to 70	°C

Note: The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded

Recommended Operating Conditions

 $(V_{SS} = 0 \text{ V}, T_{opr} = -30 \text{ to } 70^{\circ}\text{C})$

Characteristic	Symbol	Pins	Test Condition	Min	Max	Unit
			NORMAL mode	4.5		
Supply Voltage	V _{DD}	_	IDLE mode	4.5	5.5	V
			STOP mode	2.0		
Input High Voltage	V _{IH1}	Except hysteresis input		V _{DD} × 0.70	V	<
Input High Voltage	V _{IH2}	Hysteresis input	_	V _{DD} × 0.75	V _{DD}	
Input Low Voltage	V _{IL1}	Except hysteresis input		0	V _{DD} × 0.30	\ \
input Low Voltage	V _{IL2}	Hysteresis input	_	U	V _{DD} ×0.25	•
	fc (Note)	XIN, XOUT	_	1	8.0	
Clock Frequency	f	0561 0563	Normal freguency mode (FORS = 0)	2	12	MHz
	fosc	OSC1, OSC2	Double frequency mode (FORS = 1)	2	6	

Note 1: The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

Note 2: Clock frequency fc: Supply voltage range is specified in NORMAL1/2 mode and IDLE1/2 mode.

Furthermore, since the CPU clock serves dual purposes as a clock for the CCD slicer, always be sure to use an 8 MHz oscillator.

D.C. Characteristics

 $(V_{SS} = 0 \text{ V}, T_{opr} = -30 \text{ to } 70^{\circ}\text{C})$

Characteristic	Symbol	Pins	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Hysteresis Voltage	V _{HS}	Hysteresis inputs	_	_	_	0.9	_	V
	I _{IN1}	TEST	_					
Input Current	I _{IN2}	Open drain ports, Tristate ports	_	V _{DD} = 5.5 V, V _{IN} = 5.5 V / 0V	_	_	± 2	μ A
	I _{IN3}	RESET, STOP	_					
Input Resistance	R _{IN2}	RESET	_	_	100	220	450	k Ω
Output Leakage	1,01		_	V _{DD} = 5.5 V, V _{OUT} = 5.5 V / 0 V			±2	
Current	I _{LO2}	Tri-state ports	_	V _{DD} = 5.5 V, V _{OUT} = 5.5 V / 0 V]	_	12	μΑ
Output High Voltage	V _{OH2}	Tri-state ports	_	$V_{DD} = 4.5 \text{ V},$ $I_{OH} = -0.7 \text{ mA}$	4.1	_	_	V
Output Low Voltage	V _{OL}	Except XOUT, OSC2 and P63 to 60	_	V _{DD} = 4.5 V, I _{OL} = 1.6 mA	_	_	0.4	٧
Output Low Current	I _{OL3}	P63 to P60	_	V _{DD} = 4.5 V, V _{OL} = 1.0 V	_	20	_	mA
Supply Current in NORMAL Mode				$V_{DD} = 5.5 \text{ V}$	_	15	25	
Supply Current in IDLE Mode	I _{DD}	_	_	fc = 8 MHz (Note 3) V _{IN} = 5.3 V / 0.2 V	_	10	18	mA
Supply Current in STOP Mode				V _{DD} = 5.5 V V _{IN} = 5.3 V / 0.2 V	_	0.5	10	μA

Note 1: Typ. values show those at $T_{opr} = 25$ °C, $V_{DD} = 5$ V.

Note 2: Input Current I_{IN3} ; The current through resistor is not included.

Note 3: Supply Current I_{DD}; The current (Typ. 0.5 mA) through ladder resistors of ADC is included in NORMAL mode and IDLE mode.

A/D Conversion Characteristics

 $(T_{opr} = -30 \text{ to } 70^{\circ}\text{C})$

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Analog Reference Voltage	VAREF	_	Supplied from V _{DD} pin	_	V_{DD}	_	
Analog Reference Voltage Range	V _{ASS}	_	0 V, supplied from V _{SS} pin	_	0	_	_v
	∆V _{AREF}	_	$=V_{DD}-V_{SS}$	_	V_{DD}	_	'
Analog Input Voltage	VAIN	_	_	Vss	_	V_{DD}	
Nonlinearity Error	_			_	_	±1	
Zero Point Error	_]	\	_	_	±2	LCD
Full Scale Error	_	1 —	$V_{DD} = 4.5 \text{ to } 5.5 \text{ V}$	_	_	±2	LSB
Total Error	_			_	_	±3	

A.C. Chracteristics

($V_{SS} = 0 \text{ V}, V_{DD} = 4.5 \text{ to } 5.5 \text{ V}, T_{opr} = -30 \text{ to } 70^{\circ}\text{C}$)

Characteristic	Symbol	Test Circuit			Тур.	Max	Unit
Machine Cycle Time	tou		In NORMAL mode	0.5	_	4	
Iwachine Cycle Time	tcy	_	In IDLE mode	0.5			μ S
High Level Clock Pulse Width	t _{WCH}		For external clock operation	62.5			ns
Low Level Clock Pulse Width t _{WCL}		1 –	(XIN input), fc = 8 MHz	02.5	-		ns

Recommended Oscillating Conditions $(V_{SS} = 0 \text{ V}, V_{DD} = 4.5 \text{ to } 5.5 \text{ V}, T_{opr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter Oscillator		Frequency	Recomm	Recomn Cons	nended stant	
		, ,		C ₁	C ₂	
High-Frequency	Ceramic Resonator	8 MHz	KYOCERA	KBR8.0M	30 pF	30 pF
In The Control of the Control	Crystal Oscillator	8 MHz	TOYOCOM	210B 8.0000	20 pF	20 pF
OSD	I C Posenator	6 MHz	токо	A285HCIS-13319		
OSD	LC Resonator	12 MHz	токо	TBEHCIS-13306	_	_



(1) High-frequency Oscillation



(2) LC Resonator for OSD

Note: To keep reliable operation, shield the device electrically with the metal plate on its package mold surface against the high electric field, for example, by CRT (Cathode Ray Tube).

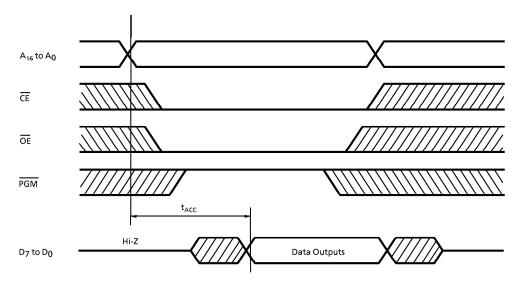
DC / AC Characteristics (PROM Mode)

 $(V_{SS} = 0 \text{ V}, T_{opr} = -30 \text{ to } 70^{\circ}\text{C})$

(1) Read operation

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Input High Voltage	V _{IH4}	_	_	$V_{CC} \times 0.7$	_	V _{CC}	V
Input Low Voltage	V _{IL4}	_	_	0	_	V _{CC} × 0.12	V
Power Supply Voltage	Vcc	_					
Program Power Supply Voltage	V _{PP}	_	_	4.75	5.0	5.25	V
Address Access Time	t _{ACC}	_	$V_{CC} = 5.0 \pm 0.25 \text{ V}$	_	1.5 tcyc + 300	_	ns

Note: tcyc = 500 ns at 8 MHz



(2) High-speed programming operation ($T_{opr} = 25 \pm 5^{\circ}C$)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Input High Voltage	V _{IH4}	_	_	$V_{CC} \times 0.7$	_	V _{CC}	٧
Input Low Voltage	V _{IL4}	_	_	0	_	V _{CC} × 0.12	٧
Power Supply Voltage	V _{CC}	_	_	6.0	6.25	6.5	٧
Program Power Supply Voltage	V _{PP}	_	_	12.5	12.75	13.0	V
Initial Program Pulse Width	t _{PW}	_	V _{CC} = 6.0 V	0.095	0.1	0.105	ms